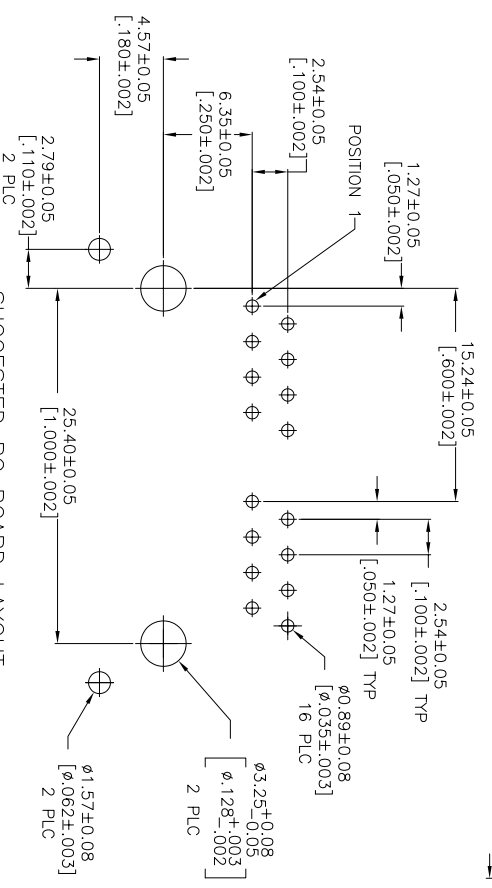


1. MATERIAL: HOUSING - NYLON, COLOR: BLACK, UL 94V-0. OVERMOLDED TERMINAL ARRAY - PBT, BROWN. TERMINALS - 0.33[0.13] THICK PHOS BRONZE PLATED WITH 1.27 μm[0.00050] MIN THICK HARD GOLD IN LOCALIZED AREA AND 3.81 μm [0.00150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 μm[0.00050] MIN THICK NICKEL UNDERPLATE. SHIELD - 0.25[0.010] THICK COPPER ALLOY PLATED WITH 1.27 μm [0.00050] MIN NICKEL AND 2.03 μm [0.00080] MIN HOT TIN DIP ON PCB GROUND TABS.

JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.

SUGGESTED PC BOARD LAYOUT
 COMPONENT SIDE
 SEE APPLICATION SPECIFICATION



THIS DRAWING IS A CONTROLLED DOCUMENT:		REV A	
DATE	01/2000	REV	00
BY	G. GARRETT/A.MAYER	DATE	12/2009
CHKD	WHITT	BY	DZ
APP'D		DATE	02/2009
DESIGNER	OWANZOO	REV	01
PART NUMBER	5558434-1	DATE	02/2009
SIZE	2 PORT, 8 POSITION, RIGHT ANGLE.	REV	02
APPLICATION SPEC	PANEL GROUND, CATEGORY 5	DATE	02/2009
REVISIONS		REV	03
1	114-2048	DATE	02/2009
2	A2 00779	REV	04
3	5558434	DATE	02/2009
4		REV	05

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4	00
3	D
2	
1	
SUGGESTED PC BOARD LAYOUT	
COMPONENT SIDE	
SEE APPLICATION SPECIFICATION	
5558434-1	
PART NUMBER	
Tyso Electronics Corporation	
Harrisburg, PA 17105-3608	
MODULAR JACK ASSEMBLY,	
2 PORT, 8 POSITION, RIGHT ANGLE.	
PANEL GROUND, CATEGORY 5	
RESTRICTED TO	
SCALE	4:1
SHEET	1 of 1
REV	D